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RAMBUS INC.,

Plaintiff,

v.

SAMSUNG ELECTRONICS CO., LTD.,
SAMSUNG ELECTRONICS AMERICA, INC.,
SAMSUNG SEMICONDUCTOR, INC.,
SAMSUNG AUSTIN SEMICONDUCTOR,
L.P.,

Defendants.

Case No. C 05-02298 RMW

RAMBUS INC.,

Plaintiff,

v.

MICRON TECHNOLOGY, INC. and MICRON
SEMICONDUCTOR PRODUCTS, INC.,

Defendants.

Case No. C 06-00244 RMW

1 JARED BOBROW (Bar No. 133712)
Email: jared.bobrow@weil.com
2 JOHN D. BEYNON (Bar No. 233581)
Email: john.beynon@weil.com
3 WEIL GOTSHAL & MANGES LLP
201 Redwood Shores Parkway
4 Redwood Shores, CA 94065
Telephone: (650) 802-3034
5 Facsimile: (650) 802-3100

6 ELIZABETH STOTLAND WEISWASSER
Email: elizabeth.weiswasser@weil.com
7 DAVID LENDER
Email: david.lender@weil.com
8 WEIL, GOTSHAL & MANGES LLP
New York Office
9 767 Fifth Avenue
New York, NY 10153
10 Telephone: (212) 310-8000
Facsimile: (646) 842-0505
11
12 WILLIAM C. PRICE (Bar No. 108542)
Email: william.price@quinnemanuel.com
13 HAROLD A. BARZA (Bar No. 80888)
Email: halbarza@quinnemanuel.com
14 JON R. STEIGER (Bar No. 229814)
Email: jonsteiger@quinnemanuel.com
15 ROBERT J. BECHER (Bar No. 193431)
Email: robertbecher@quinnemanuel.com
16 QUINN EMANUEL URQUHART OLIVER & HEDGES, LLP
865 South Figueroa Street, 10th Floor
17 Los Angeles, CA 90017
Telephone: (213) 443-3000
18 Facsimile: (213) 443-3100

19 Attorneys for Defendants
MICRON TECHNOLOGY, INC. and
20 MICRON SEMICONDUCTOR PRODUCTS, INC.

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22
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24
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26
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1 MATTHEW D. POWERS
Email: matthew.powers@weil.com
2 STEVEN S. CHERENSKY
Email: steven.cherensky@weil.com
3 WEIL GOTSHAL & MANGES LLP
201 Redwood Shores Parkway
4 Redwood Shores, CA 94065
Telephone: (650) 802-3034
5 Facsimile: (650) 802-3100

6 ROBERT S. BEREZIN
Email: robert.berezin@weil.com
7 WEIL, GOTSHAL & MANGES LLP
New York Office
8 767 Fifth Avenue
New York, NY 10153
9 Telephone: (212) 310-8000

10 Attorneys for Defendants
SAMSUNG ELECTRONICS CO., LTD.,
11 SAMSUNG ELECTRONICS AMERICA, INC.,
SAMSUNG SEMICONDUCTOR, INC., and
12 SAMSUNG AUSTIN SEMICONDUCTOR, L.P.

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1 As set forth in defendants Micron Technology, Inc., Micron Semiconductor
2 Products, Inc., Samsung Electronics Co., LTD., Samsung Electronics America, Inc., Samsung
3 Semiconductor, Inc., and Samsung Austin Semiconductor, L.P.'s Miscellaneous Administrative
4 Request Pursuant To Civil Local Rules 7-10 and 79-5 To Seal Documents, Defendants lodged
5 with the Court the following documents in connection with their Reply In Further Support Of
6 Their Motion For Summary Judgment Regarding Certain Damages Issues And Related Daubert
7 Motions To Preclude David J. Teece From Offering Testimony On Such Issues (MSJ No. 8) and
8 Reply In Further Support Of Their Joint Daubert Motion And Motions In Limine Regarding
9 Certain Damages Issues (Daubert No. 9):

10 • The Confidential version of Micron Technology, Inc., Micron
11 Semiconductor Products, Inc., Samsung Electronics Co., Ltd., Samsung Electronics America,
12 Inc., Samsung Semiconductor, Inc., And Samsung Austin Semiconductor, L.P.'s Reply In Further
13 Support Of Their Motion For Summary Judgment Regarding Certain Damages Issues And
14 Related Daubert Motions To Preclude David J. Teece From Offering Testimony On Such Issues
15 (MSJ No. 8).

16 • **Exhibit A** to the Declaration of David J. Lender in Support of Micron and
17 Samsung's Confidential Reply MSJ No. 8. This exhibit is a true and correct copy of excerpts
18 from the expert report of Stephen D. Prowse, Ph.D, dated 9/26/2008.

19 • **Exhibit B** to the Declaration of David J. Lender in Support of Micron and
20 Samsung's Confidential Reply MSJ No. 8. This exhibit is a true and correct copy of excerpts
21 from the deposition of David J. Teece, dated 10/21/2008.

22 • The Confidential version of Micron Technology, Inc., Micron
23 Semiconductor Products, Inc., Samsung Electronics Co., Ltd., Samsung Electronics America,
24 Inc., Samsung Semiconductor, Inc., And Samsung Austin Semiconductor, L.P.'s Reply In Further
25 Support Of Their Joint Daubert Motion And Motions In Limine Regarding Certain Damages
26 Issues (Daubert No. 9).

27 Having considered Defendants' Miscellaneous Administrative Request, and good
28 cause appearing,

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IT IS HEREBY ORDERED that the Confidential version of Micron Technology, Inc., Micron Semiconductor Products, Inc., Samsung Electronics Co., Ltd., Samsung Electronics America, Inc., Samsung Semiconductor, Inc., And Samsung Austin Semiconductor, L.P.'s Reply In Further Support Of Their Motion For Summary Judgment Regarding Certain Damages Issues And Related Daubert Motions To Preclude David J. Teece From Offering Testimony On Such Issues (MSJ No. 8) and Exhibits A & B to the Declaration of David J. Lender in Support thereof are to be filed under seal.

IT IS HEREBY ORDERED that the Confidential version of Micron Technology, Inc., Micron Semiconductor Products, Inc., Samsung Electronics Co., Ltd., Samsung Electronics America, Inc., Samsung Semiconductor, Inc., And Samsung Austin Semiconductor, L.P.'s Reply In Further Support Of Their Joint Daubert Motion And Motions In Limine Regarding Certain Damages Issues (Daubert No. 9) is to be filed under seal.

Dated: 12/23/08



The Honorable Ronald M. Whyte
United States District Court Judge